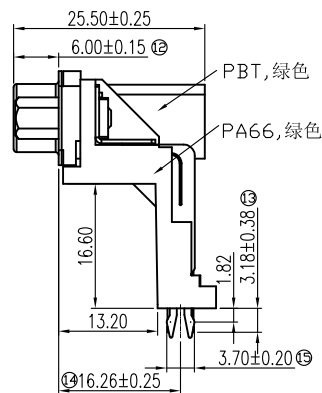
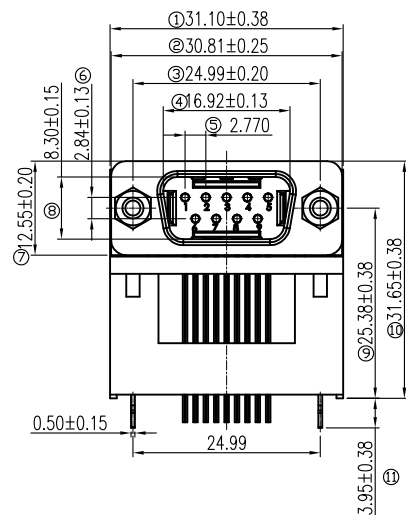
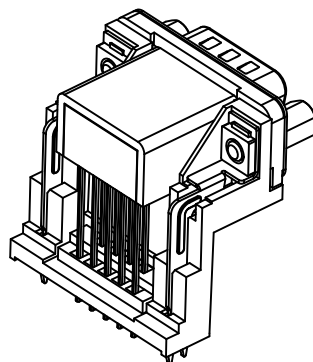
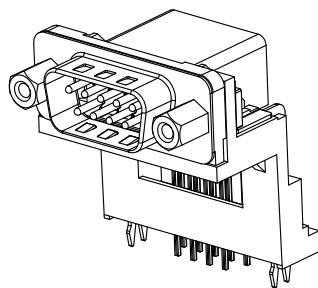


RECOMMENDED P.C.B LAYOUT



SPECIFICATIONS

1. D-SUB
- 1.1 Voltage: 250 VAC(RMS) Max.
- 1.2 Current Rating: 3 Ampere per Contact
- 1.3 Contact Resistance: 25 Milliohms Max.
- 1.4 Insulation Resistance: 5000 Megohms Min.
- 1.5 Dielectric Withstanding Voltage: 1000V AC(RMS)
- 1.6 Total Mating Force: 6.0 Kgf Max.
- 1.7 Total Unmating Force: 1.2 Kgf Min.
- 1.8 Operating Temperature: -55°C to +85°C

NOTES

1. MATERIAL:
Housing:PBT, UL 94V-0, Color:322C Green.
Bracket:PA66, UL 94V-0, Color:322C Green.
Terminal:Copper Alloy.
Shell:SPCC.
Boardlock:SPCC.
Rivet:Copper Alloy.
Screw:Steel.
2. FINISH:
Terminal:Au G/F Plated over Nickel 50u"Min Plated at Contact Area. Matte Tin 100u"Min Plated over Nickel 50u"Min Plated at Solder Ared.
Shell:Nickel 50u" Min Plated.
Boardlock:Tin 100u" Min Plated.
Rivet:Nickel 50u" Min Plated.
Screw:Nickel 50u" Min Plated.
3. This Product is LEAD-FREE & RoHS Compliance Product.



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X' ±2" X.X' ±0.5"	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: DR9公 架高 塑胶支架 竖叉 铆锁
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYCW258-VGA09A-316B
UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 邱敏	DATE : 2014-02-23	MOLD NO.
			DRAW NO: HYC-2606111202
			SHEET NO. 1 OF 1